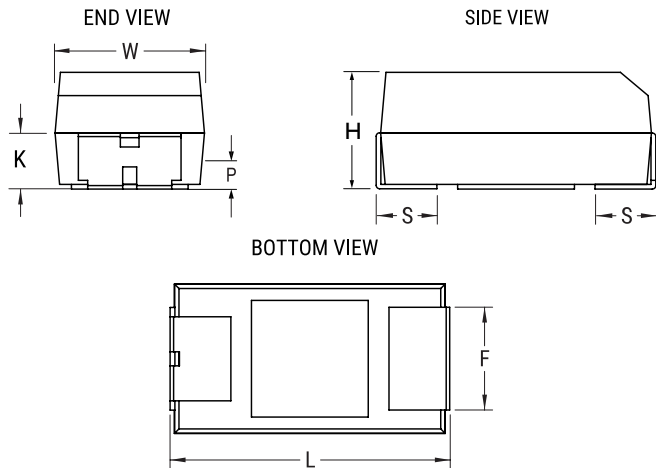


T581X336M035YH801B

Aliases (M3270002E336MMHYB)

T581, Tantalum, Polymer Tantalum, Polymer Military/High Reliability, 33 uF, 20%, 35 VDC, SMD, MnO₂, Molded, Military Equivalent, 80 mOhms, 4.4 mm, 1.3 mm



Click [here](#) for the 3D model.

General Information

Series	T581
Dielectric	Polymer Tantalum
Style	SMD Chip
Description	SMD, MnO ₂ , Molded, Military Equivalent
RoHS	No
Prop 65	WARNING: Cancer and reproductive harm - https://www.p65warnings.ca.gov/
Termination	Tin Lead (SnPb)
AEC-Q200	No
Typical Component Weight	410.89 mg
Shelf Life	52 Weeks
MSL	3

Specifications

Capacitance	33 uF
Tolerance	20%
Voltage DC	35 VDC (85C), 23.45 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	85°C
Dissipation Factor	10% 120Hz 25C
Failure Rate	C (0.01%/1000 Hrs)
ESR	80 mOhms (100kHz 25C)
Ripple Current	2236 mA (rms, 100kHz 45C)
Leakage Current	116 uA (5min 25°C)

Dimensions

L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
H	4mm +/-0.4mm
S	1.3mm +/-0.3mm
F	2.4mm +/-0.2mm
K	1.98mm MIN

Packaging Specifications

Packaging	T&R, 178mm
Packaging Quantity	500

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